

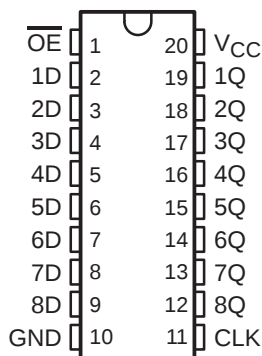
# SN54LVTH574, SN74LVTH574

## 3.3-V ABT OCTAL EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

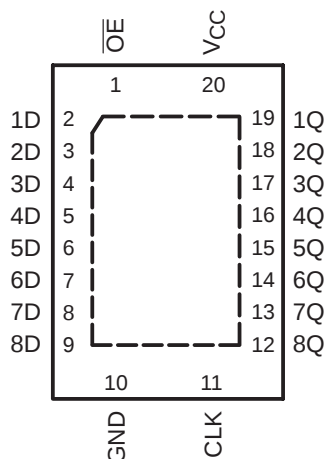
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- Support Mixed-Mode Signal Operation (5-V Input and Output Voltages With 3.3-V  $V_{CC}$ )
- Support Unregulated Battery Operation Down to 2.7 V
- Typical  $V_{OLP}$  (Output Ground Bounce)  $<0.8$  V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- $I_{off}$  and Power-Up 3-State Support Hot Insertion
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Latch-Up Performance Exceeds 500 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)

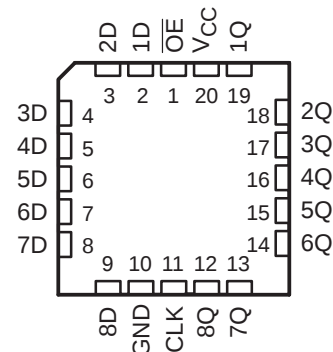
SN54LVTH574... J OR W PACKAGE  
SN74LVTH574... DB, DW, NS,  
OR PW PACKAGE  
(TOP VIEW)



SN74LVTH574... RGY PACKAGE  
(TOP VIEW)



SN54LVTH574... FK PACKAGE  
(TOP VIEW)



### description/ordering information

These octal flip-flops are designed specifically for low-voltage (3.3-V)  $V_{CC}$  operation, but with the capability to provide a TTL interface to a 5-V system environment.

### ORDERING INFORMATION

| $T_A$          | PACKAGE†              |               | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-----------------------|---------------|-----------------------|------------------|
| -40°C to 85°C  | QFN – RGY             | Tape and reel | SN74LVTH574RGYR       | LXH574           |
|                | SOIC – DW             | Tube          | SN74LVTH574DW         | LVTH574          |
|                |                       | Tape and reel | SN74LVTH574DWR        |                  |
|                | SOP – NS              | Tape and reel | SN74LVTH574NSR        | LVTH574          |
|                | SSOP – DB             | Tape and reel | SN74LVTH574DBR        | LXH574           |
|                | TSSOP – PW            | Tube          | SN74LVTH574PW         | LXH574           |
|                |                       | Tape and reel | SN74LVTH574PWR        |                  |
| -55°C to 125°C | VFBGA – GQN           | Tape and reel | SN74LVTH574GQNR       | LXH574           |
|                | VFBGA – ZQN (Pb-free) |               | SN74LVTH574ZQNR       |                  |
|                | CDIP – J              | Tube          | SNJ54LVTH574J         | SNJ54LVTH574J    |
|                | CFP – W               | Tube          | SNJ54LVTH574W         | SNJ54LVTH574W    |
|                | LCCC – FK             | Tube          | SNJ54LVTH574FK        | SNJ54LVTH574FK   |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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3.3-V ABT OCTAL EDGE-TRIGGERED D-TYPE FLIP-FLOPS  
WITH 3-STATE OUTPUTS

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description/ordering information (continued)

The eight flip-flops of the 'LVTH574 devices are edge-triggered D-type flip-flops. On the positive transition of the clock (CLK) input, the Q outputs are set to the logic levels set up at the data (D) inputs.

A buffered output-enable ( $\overline{OE}$ ) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without need for interface or pullup components.

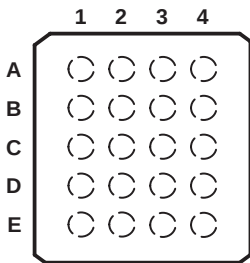
$\overline{OE}$  does not affect the internal operations of the flip-flops. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

These devices are fully specified for hot-insertion applications using  $I_{off}$  and power-up 3-state. The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.

SN74LVTH574 . . . GQN OR ZQN PACKAGE  
(TOP VIEW)



terminal assignments

|   | 1   | 2               | 3        | 4  |
|---|-----|-----------------|----------|----|
| A | 1D  | $\overline{OE}$ | $V_{CC}$ | 1Q |
| B | 3D  | 3Q              | 2D       | 2Q |
| C | 5D  | 4D              | 5Q       | 4Q |
| D | 7D  | 7Q              | 6D       | 6Q |
| E | GND | 8D              | CLK      | 8Q |

FUNCTION TABLE  
(each flip-flop)

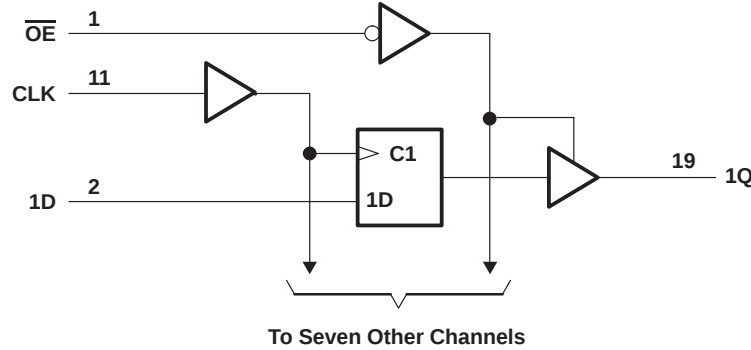
| INPUTS          |        |   | OUTPUT<br>Q |
|-----------------|--------|---|-------------|
| $\overline{OE}$ | CLK    | D |             |
| L               | ↑      | H | H           |
| L               | ↑      | L | L           |
| L               | H or L | X | $Q_0$       |
| H               | X      | X | Z           |

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## 3.3-V ABT OCTAL EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

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### logic diagram (positive logic)



Pin numbers shown are for the DB, DW, FK, J, NS, PW, RGY, and W packages.

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

|                                                                                                  |                            |
|--------------------------------------------------------------------------------------------------|----------------------------|
| Supply voltage range, $V_{CC}$                                                                   | –0.5 V to 4.6 V            |
| Input voltage range, $V_I$ (see Note 1)                                                          | –0.5 V to 7 V              |
| Voltage range applied to any output in the high-impedance or power-off state, $V_O$ (see Note 1) | –0.5 V to 7 V              |
| Voltage range applied to any output in the high state, $V_O$ (see Note 1)                        | –0.5 V to $V_{CC} + 0.5$ V |
| Current into any output in the low state, $I_O$ : SN54LVTH574                                    | 96 mA                      |
| SN74LVTH574                                                                                      | 128 mA                     |
| Current into any output in the high state, $I_O$ (see Note 2): SN54LVTH574                       | 48 mA                      |
| SN74LVTH574                                                                                      | 64 mA                      |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )                                                      | –50 mA                     |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ )                                                     | –50 mA                     |
| Package thermal impedance, $\theta_{JA}$ (see Note 3): DB package                                | 70°C/W                     |
| (see Note 3): DW package                                                                         | 58°C/W                     |
| (see Note 3): GQN/ZQN package                                                                    | 78°C/W                     |
| (see Note 3): NS package                                                                         | 60°C/W                     |
| (see Note 3): PW package                                                                         | 83°C/W                     |
| (see Note 4): RGY package                                                                        | 37°C/W                     |
| Storage temperature range, $T_{stg}$                                                             | –65°C to 150°C             |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
  2. This current flows only when the output is in the high state and  $V_O > V_{CC}$ .
  3. The package thermal impedance is calculated in accordance with JESD 51-7.
  4. The package thermal impedance is calculated in accordance with JESD 51-5.

# SN54LVTH574, SN74LVTH574

## 3.3-V ABT OCTAL EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

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### recommended operating conditions (see Note 5)

|                          |                                    | SN54LVTH574     |     | SN74LVTH574 |     | UNIT      |
|--------------------------|------------------------------------|-----------------|-----|-------------|-----|-----------|
|                          |                                    | MIN             | MAX | MIN         | MAX |           |
| $V_{CC}$                 | Supply voltage                     | 2.7             | 3.6 | 2.7         | 3.6 | V         |
| $V_{IH}$                 | High-level input voltage           | 2               |     | 2           |     | V         |
| $V_{IL}$                 | Low-level input voltage            |                 | 0.8 |             | 0.8 | V         |
| $V_I$                    | Input voltage                      |                 | 5.5 |             | 5.5 | V         |
| $I_{OH}$                 | High-level output current          |                 | –24 |             | –32 | mA        |
| $I_{OL}$                 | Low-level output current           |                 | 48  |             | 64  | mA        |
| $\Delta t/\Delta v$      | Input transition rise or fall rate | Outputs enabled |     |             | 10  | ns/V      |
| $\Delta t/\Delta V_{CC}$ | Power-up ramp rate                 |                 | 200 |             | 200 | $\mu$ s/V |
| $T_A$                    | Operating free-air temperature     | –55             | 125 | –40         | 85  | °C        |

NOTE 5: All unused control inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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## 3.3-V ABT OCTAL EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER             |                | TEST CONDITIONS                                                                                              |                                  | SN54LVTH574          |      |     | SN74LVTH574          |      |     | UNIT |    |
|-----------------------|----------------|--------------------------------------------------------------------------------------------------------------|----------------------------------|----------------------|------|-----|----------------------|------|-----|------|----|
|                       |                |                                                                                                              |                                  | MIN                  | TYP† | MAX | MIN                  | TYP† | MAX |      |    |
| V <sub>IK</sub>       |                | V <sub>CC</sub> = 2.7 V, I <sub>I</sub> = -18 mA                                                             |                                  | -1.2                 |      |     | -1.2                 |      |     | V    |    |
| V <sub>OH</sub>       |                | V <sub>CC</sub> = 2.7 V to 3.6 V, I <sub>OH</sub> = -100 μA                                                  |                                  | V <sub>CC</sub> -0.2 |      |     | V <sub>CC</sub> -0.2 |      |     | V    |    |
|                       |                | V <sub>CC</sub> = 2.7 V, I <sub>OH</sub> = -8 mA                                                             |                                  | 2.4                  |      |     | 2.4                  |      |     |      |    |
|                       |                | V <sub>CC</sub> = 3 V                                                                                        | I <sub>OH</sub> = -24 mA         | 2                    |      |     |                      |      |     |      |    |
|                       |                |                                                                                                              | I <sub>OH</sub> = -32 mA         |                      |      |     | 2                    |      |     |      |    |
| V <sub>OL</sub>       |                | V <sub>CC</sub> = 2.7 V                                                                                      | I <sub>OL</sub> = 100 μA         | 0.2                  |      |     | 0.2                  |      |     | V    |    |
|                       |                |                                                                                                              | I <sub>OL</sub> = 24 mA          | 0.5                  |      |     | 0.5                  |      |     |      |    |
|                       |                | V <sub>CC</sub> = 3 V                                                                                        | I <sub>OL</sub> = 16 mA          | 0.4                  |      |     | 0.4                  |      |     |      |    |
|                       |                |                                                                                                              | I <sub>OL</sub> = 32 mA          | 0.5                  |      |     | 0.5                  |      |     |      |    |
|                       |                |                                                                                                              | I <sub>OL</sub> = 48 mA          | 0.55                 |      |     |                      |      |     |      |    |
|                       |                |                                                                                                              | I <sub>OL</sub> = 64 mA          |                      |      |     | 0.55                 |      |     |      |    |
| I <sub>I</sub>        | Control inputs | V <sub>CC</sub> = 0 or 3.6 V, V <sub>I</sub> = 5.5 V                                                         |                                  | 10                   |      |     | 10                   |      |     | μA   |    |
|                       |                | V <sub>CC</sub> = 3.6 V, V <sub>I</sub> = V <sub>CC</sub> or GND                                             |                                  | ±1                   |      |     | ±1                   |      |     |      |    |
|                       | Data inputs    | V <sub>CC</sub> = 3.6 V                                                                                      | V <sub>I</sub> = V <sub>CC</sub> |                      | 1    |     |                      | 1    |     |      |    |
|                       |                |                                                                                                              | V <sub>I</sub> = 0               |                      | -5   |     |                      | -5   |     |      |    |
| I <sub>off</sub>      |                | V <sub>CC</sub> = 0, V <sub>I</sub> or V <sub>O</sub> = 0 to 4.5 V                                           |                                  |                      |      |     | ±100                 |      |     | μA   |    |
| I <sub>I</sub> (hold) | Data inputs    | V <sub>CC</sub> = 3 V                                                                                        | V <sub>I</sub> = 0.8 V           |                      | 75   |     |                      | 75   |     |      | μA |
|                       |                |                                                                                                              | V <sub>I</sub> = 2 V             |                      | -75  |     |                      | -75  |     |      |    |
|                       |                | V <sub>CC</sub> = 3.6 V‡, V <sub>I</sub> = 0 to 3.6 V                                                        |                                  |                      |      |     | ±500                 |      |     |      |    |
| I <sub>OZH</sub>      |                | V <sub>CC</sub> = 3.6 V, V <sub>O</sub> = 3 V                                                                |                                  | 5                    |      |     | 5                    |      |     | μA   |    |
| I <sub>OZL</sub>      |                | V <sub>CC</sub> = 3.6 V, V <sub>O</sub> = 0.5 V                                                              |                                  | -5                   |      |     | -5                   |      |     | μA   |    |
| I <sub>OZPU</sub>     |                | V <sub>CC</sub> = 0 to 1.5 V, V <sub>O</sub> = 0.5 V to 3 V, OE = don't care                                 |                                  | ±100*                |      |     | ±100                 |      |     | μA   |    |
| I <sub>OZPD</sub>     |                | V <sub>CC</sub> = 1.5 V to 0, V <sub>O</sub> = 0.5 V to 3 V, OE = don't care                                 |                                  | ±100*                |      |     | ±100                 |      |     | μA   |    |
| I <sub>CC</sub>       |                | V <sub>CC</sub> = 3.6 V, I <sub>O</sub> = 0, V <sub>I</sub> = V <sub>CC</sub> or GND                         | Outputs high                     |                      | 0.19 |     |                      | 0.19 |     |      | mA |
|                       |                |                                                                                                              | Outputs low                      |                      | 5    |     |                      | 5    |     |      |    |
|                       |                |                                                                                                              | Outputs disabled                 |                      | 0.19 |     |                      | 0.19 |     |      |    |
| ΔI <sub>CC</sub> §    |                | V <sub>CC</sub> = 3 V to 3.6 V, One input at V <sub>CC</sub> - 0.6 V, Other inputs at V <sub>CC</sub> or GND |                                  | 0.2                  |      |     | 0.2                  |      |     | mA   |    |
| C <sub>i</sub>        |                | V <sub>I</sub> = 3 V or 0                                                                                    |                                  | 3                    |      |     | 3                    |      |     | pF   |    |
| C <sub>O</sub>        |                | V <sub>O</sub> = 3 V or 0                                                                                    |                                  | 7                    |      |     | 7                    |      |     | pF   |    |

\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

<sup>†</sup> All typical values are at  $V_{CC} = 3.3\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

<sup>‡</sup> This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

<sup>§</sup> This is the increase in supply current for each input that is at the specified TTL voltage level, rather than  $V_{CC}$  or GND.

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timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

|                    |                                 | SN54LVTH574                        |     |                         |     | SN74LVTH574                        |     |                         |     | UNIT |
|--------------------|---------------------------------|------------------------------------|-----|-------------------------|-----|------------------------------------|-----|-------------------------|-----|------|
|                    |                                 | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |     | V <sub>CC</sub> = 2.7 V |     | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |     | V <sub>CC</sub> = 2.7 V |     |      |
|                    |                                 | MIN                                | MAX | MIN                     | MAX | MIN                                | MAX | MIN                     | MAX |      |
| f <sub>clock</sub> | Clock frequency                 | 150                                |     | 150                     |     | 150                                |     | 150                     |     | MHz  |
| t <sub>W</sub>     | Pulse duration, CLK high or low | 3.3                                |     | 3.3                     |     | 3.3                                |     | 3.3                     |     | ns   |
| t <sub>SU</sub>    | Setup time, data before CLK↑    | 2                                  |     | 2.4                     |     | 2                                  |     | 2.4                     |     | ns   |
| t <sub>H</sub>     | Hold time, data after CLK↑      | 0.9                                |     | 0.9                     |     | 0.3                                |     | 0                       |     | ns   |

switching characteristics over recommended free-air temperature,  $C_L = 50\text{ pF}$  (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | SN54LVTH574                        |     |                         |     | SN74LVTH574                        |      |                         |     | UNIT |     |
|------------------|-----------------|----------------|------------------------------------|-----|-------------------------|-----|------------------------------------|------|-------------------------|-----|------|-----|
|                  |                 |                | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |     | V <sub>CC</sub> = 2.7 V |     | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |      | V <sub>CC</sub> = 2.7 V |     |      |     |
|                  |                 |                | MIN                                | MAX | MIN                     | MAX | MIN                                | TYP† | MAX                     | MIN |      | MAX |
| f <sub>max</sub> |                 |                | 150                                |     | 150                     |     | 150                                |      | 150                     |     | MHz  |     |
| t <sub>PLH</sub> | CLK             | Q              | 1.7                                | 4.9 | 5.9                     |     | 1.8                                | 3    | 4.5                     | 5.3 |      | ns  |
| t <sub>PHL</sub> |                 |                | 1.7                                | 4.9 | 5.5                     |     | 1.8                                | 3    | 4.5                     | 5.3 |      |     |
| t <sub>PZH</sub> | OE              | Q              | 1.4                                | 5.1 | 6.5                     |     | 1.5                                | 3.2  | 4.8                     | 5.9 |      | ns  |
| t <sub>PZL</sub> |                 |                | 1.4                                | 5.1 | 6.1                     |     | 1.5                                | 3.5  | 4.8                     | 5.9 |      |     |
| t <sub>PHZ</sub> | OE              | Q              | 1                                  | 5.9 | 6.4                     |     | 2                                  | 3.5  | 4.8                     | 5.1 |      | ns  |
| t <sub>PLZ</sub> |                 |                | 0.8                                | 4.8 | 5.3                     |     | 2                                  | 3.2  | 4.4                     | 4.4 |      |     |

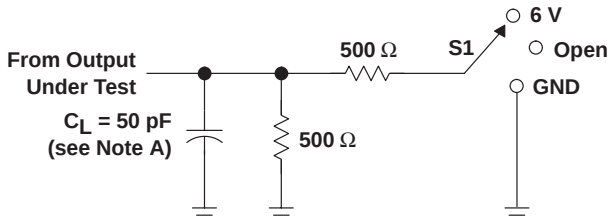
$^\dagger$  All typical values are at  $V_{CC} = 3.3\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

# SN54LVTH574, SN74LVTH574

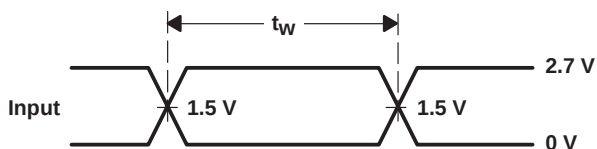
## 3.3-V ABT OCTAL EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

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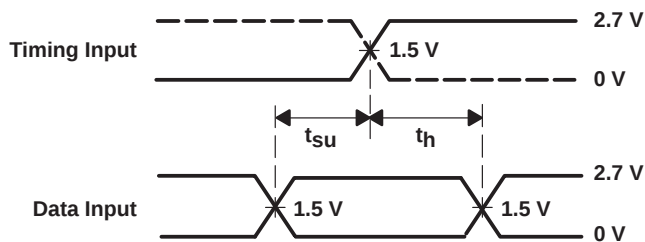
### PARAMETER MEASUREMENT INFORMATION



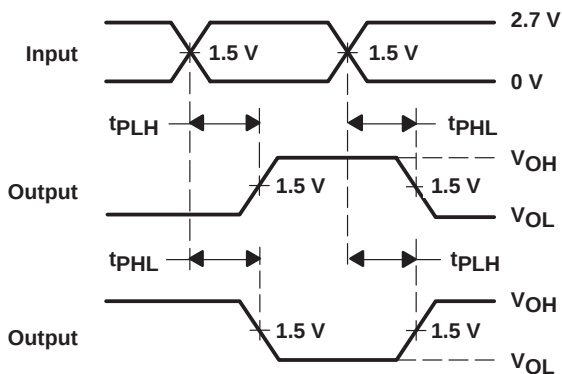
LOAD CIRCUIT



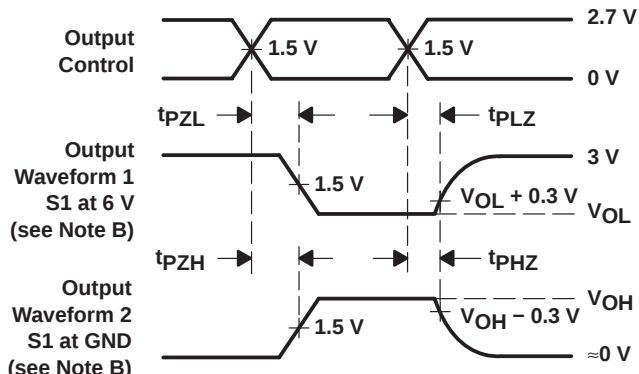
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- A.  $C_L$  includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
  - D. The outputs are measured one at a time with one transition per measurement.
  - E. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup>               |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|--------------------------------------------|
| 5962-9583201Q2A  | ACTIVE                | LCCC         | FK              | 20   | 1           | None                    | Call TI          | Level-NC-NC-NC                             |
| 5962-9583201QRA  | ACTIVE                | CDIP         | J               | 20   | 1           | None                    | Call TI          | Level-NC-NC-NC                             |
| 5962-9583201QSA  | ACTIVE                | CFP          | W               | 20   | 1           | None                    | Call TI          | Level-NC-NC-NC                             |
| 5962-9583201VRA  | ACTIVE                | CDIP         | J               | 20   | 1           | None                    | Call TI          | Level-NC-NC-NC                             |
| 5962-9583201VSA  | ACTIVE                | CFP          | W               | 20   | 1           | None                    | Call TI          | Level-NC-NC-NC                             |
| SN74LVTH574DBLE  | OBSOLETE              | SSOP         | DB              | 20   |             | None                    | Call TI          | Call TI                                    |
| SN74LVTH574DBR   | ACTIVE                | SSOP         | DB              | 20   | 2000        | Pb-Free (RoHS)          | CU NIPDAU        | Level-2-260C-1 YEAR/<br>Level-1-235C-UNLIM |
| SN74LVTH574DW    | ACTIVE                | SOIC         | DW              | 20   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | Level-2-250C-1 YEAR/<br>Level-1-235C-UNLIM |
| SN74LVTH574DWR   | ACTIVE                | SOIC         | DW              | 20   | 2000        | Pb-Free (RoHS)          | CU NIPDAU        | Level-2-250C-1 YEAR/<br>Level-1-235C-UNLIM |
| SN74LVTH574GQNR  | ACTIVE                | VFBGA        | GQN             | 20   | 1000        | None                    | SNPB             | Level-1-240C-UNLIM                         |
| SN74LVTH574NSR   | ACTIVE                | SO           | NS              | 20   | 2000        | Pb-Free (RoHS)          | CU NIPDAU        | Level-2-260C-1 YEAR/<br>Level-1-235C-UNLIM |
| SN74LVTH574PW    | ACTIVE                | TSSOP        | PW              | 20   | 70          | Pb-Free (RoHS)          | CU NIPDAU        | Level-1-250C-UNLIM                         |
| SN74LVTH574PWLE  | OBSOLETE              | TSSOP        | PW              | 20   |             | None                    | Call TI          | Call TI                                    |
| SN74LVTH574PWR   | ACTIVE                | TSSOP        | PW              | 20   | 2000        | Pb-Free (RoHS)          | CU NIPDAU        | Level-1-250C-UNLIM                         |
| SN74LVTH574RGYR  | ACTIVE                | QFN          | RGY             | 20   | 1000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1YEAR                         |
| SN74LVTH574ZQNR  | ACTIVE                | VFBGA        | ZQN             | 20   | 1000        | Pb-Free (RoHS)          | SNAGCU           | Level-1-260C-UNLIM                         |
| SNJ54LVTH574FK   | ACTIVE                | LCCC         | FK              | 20   | 1           | None                    | Call TI          | Level-NC-NC-NC                             |
| SNJ54LVTH574J    | ACTIVE                | CDIP         | J               | 20   | 1           | None                    | Call TI          | Level-NC-NC-NC                             |
| SNJ54LVTH574W    | ACTIVE                | CFP          | W               | 20   | 1           | None                    | Call TI          | Level-NC-NC-NC                             |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - May not be currently available - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**None:** Not yet available Lead (Pb-Free).

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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J (R-GDIP-T\*\*)

14 LEADS SHOWN

# CERAMIC DUAL IN-LINE PACKAGE



| PINS **<br>DIM | 14                     | 16                     | 18                     | 20                     |
|----------------|------------------------|------------------------|------------------------|------------------------|
| A              | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX          | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN          | —                      | —                      | —                      | —                      |
| C MAX          | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN          | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |

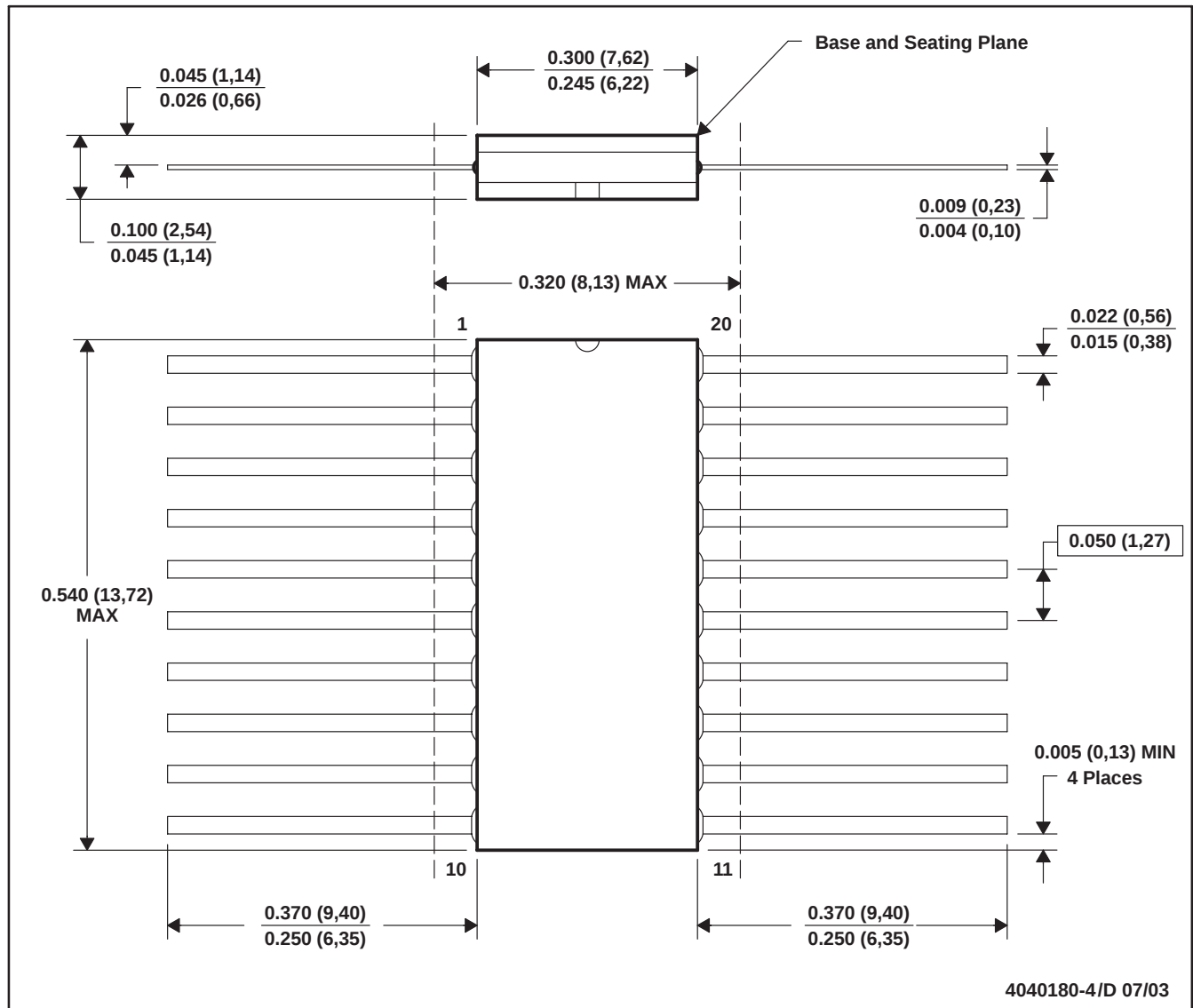


4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## W (R-GDFP-F20)

## CERAMIC DUAL FLATPACK



- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a ceramic lid using glass frit.
  - Index point is provided on cap for terminal identification only.
  - Falls within Mil-Std 1835 GDFP2-F20

FK (S-CQCC-N\*\*)

LEADLESS CERAMIC CHIP CARRIER

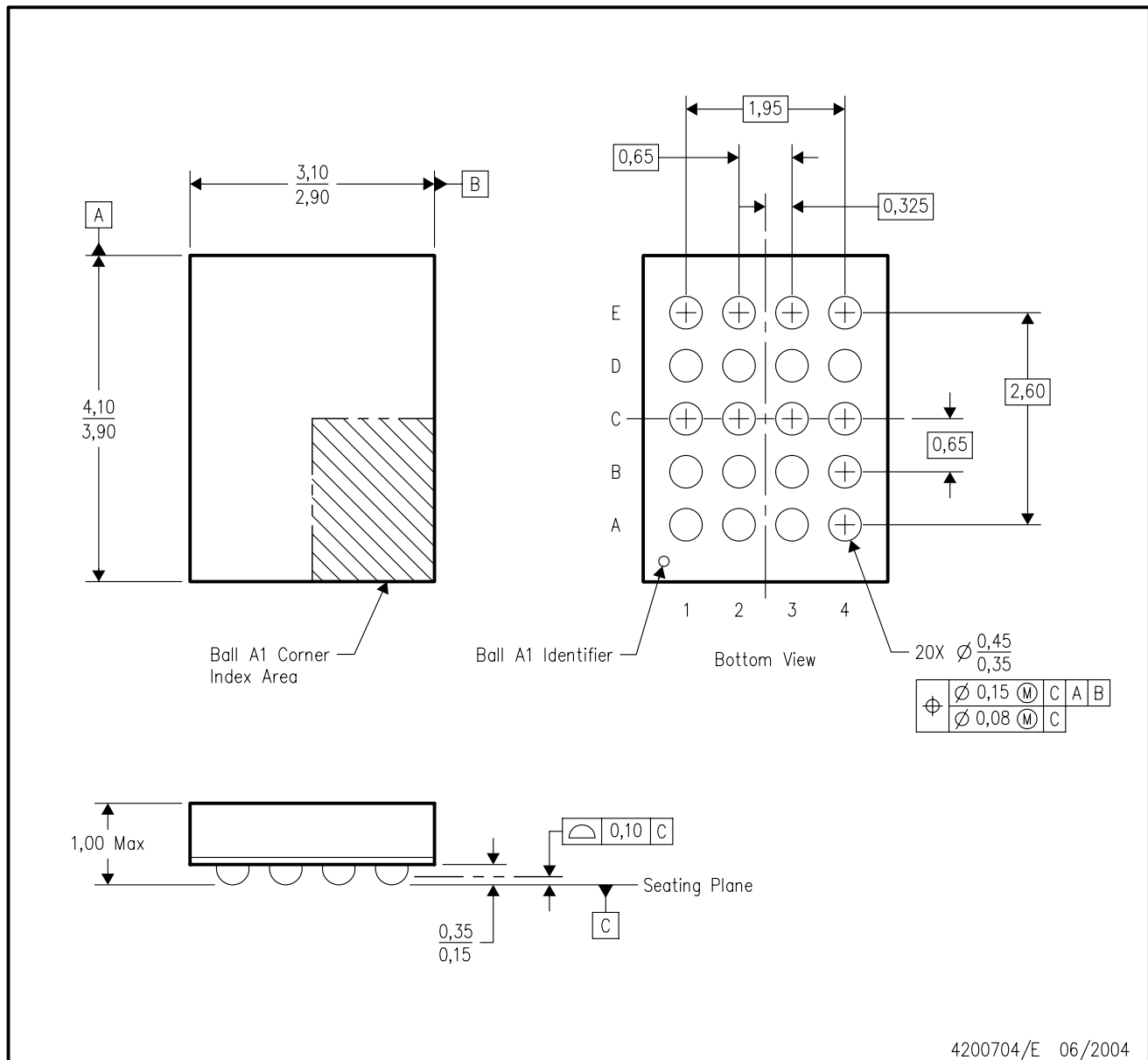
28 TERMINAL SHOWN



- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a metal lid.
  - The terminals are gold plated.
  - Falls within JEDEC MS-004

## GQN (R-PBGA-N20)

## PLASTIC BALL GRID ARRAY

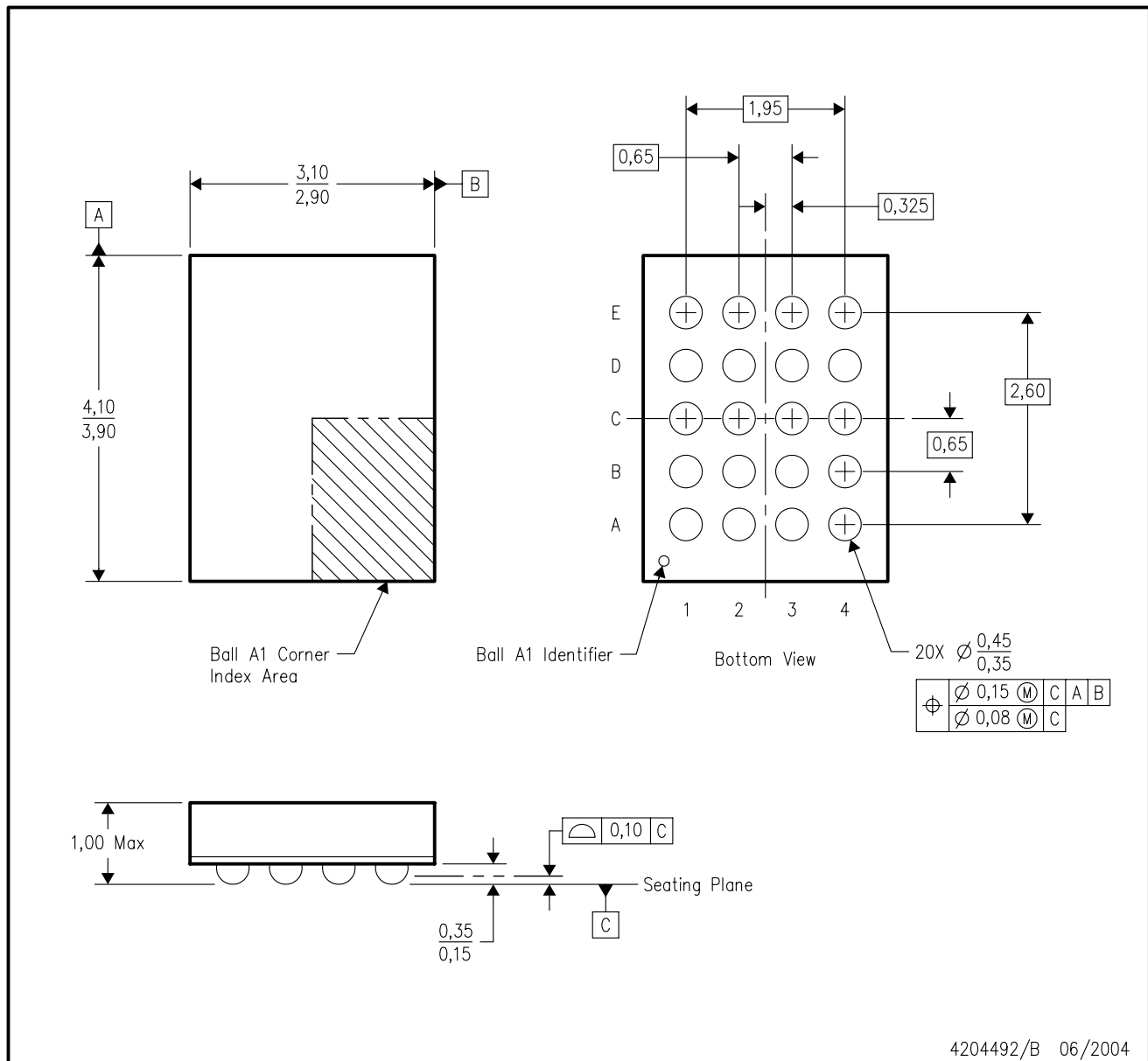


4200704/E 06/2004

- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Falls within JEDEC MO-225 variation BC.
  - This package is tin-lead (SnPb). Refer to the 20 ZQN package (drawing 4204492) for lead-free.

## ZQN (R-PBGA-N20)

## PLASTIC BALL GRID ARRAY



4204492/B 06/2004

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MO-225 variation BC.
  - D. This package is lead-free. Refer to the 20 GQN package (drawing 4200704) for tin-lead (SnPb).

## DW (R-PDSO-G20)

## PLASTIC SMALL-OUTLINE PACKAGE

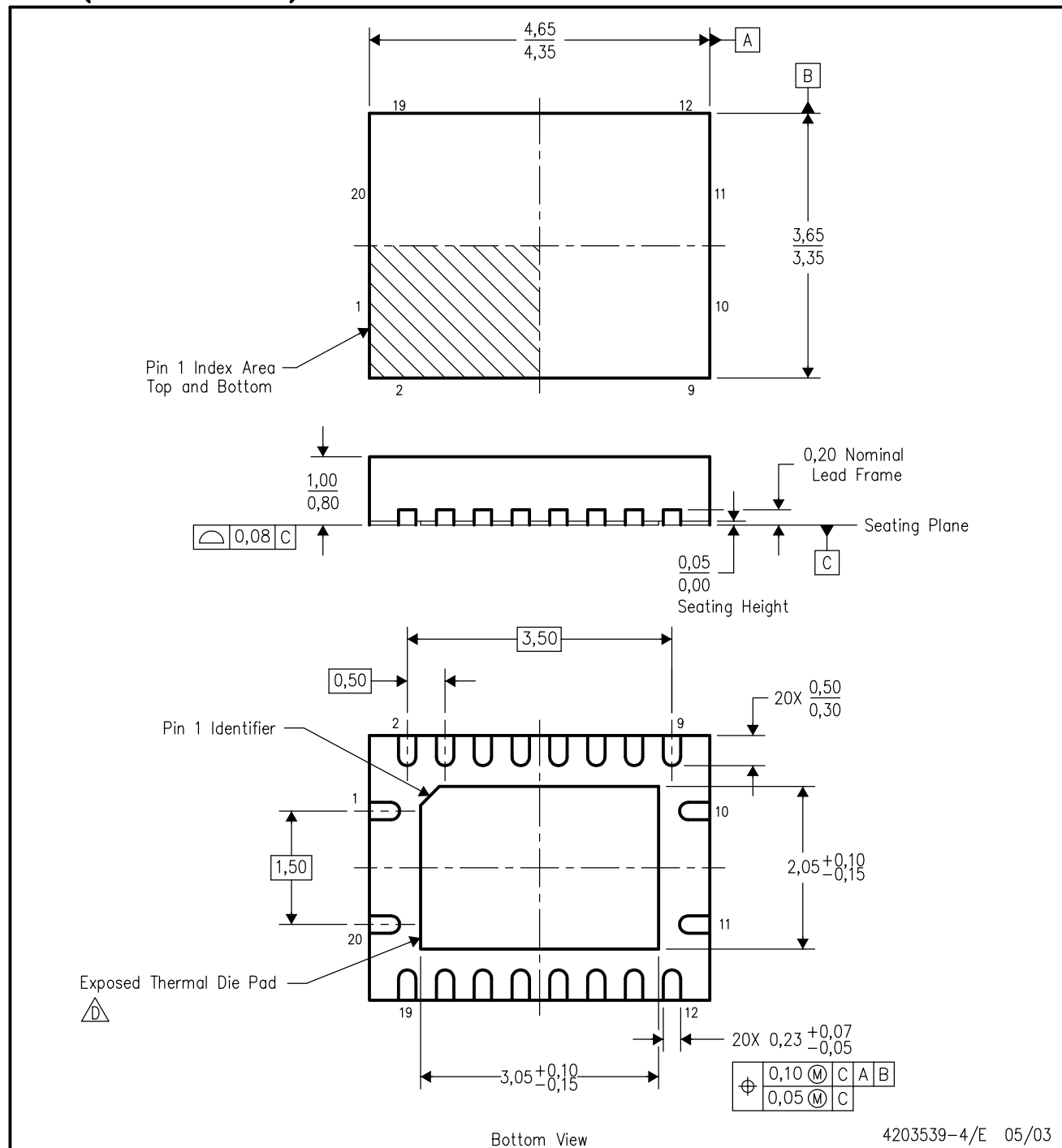


4040000-4/F 06/2004

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - Falls within JEDEC MS-013 variation AC.

RGY (R-PQFP-N20)

PLASTIC QUAD FLATPACK



4203539-4/E 05/03

NOTES:

- All linear dimensions are in millimeters.
- This drawing is subject to change without notice.
- QFN (Quad Flatpack No-Lead) package configuration.
- The package thermal performance may be enhanced by bonding the thermal die pad to an external thermal plane. This pad is electrically and thermally connected to the backside of the die and possibly selected ground leads.
- Package complies to JEDEC MO-241 variation BC.

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



| DIM \ PINS ** | 14    | 16    | 20    | 24    |
|---------------|-------|-------|-------|-------|
| A MAX         | 10,50 | 10,50 | 12,90 | 15,30 |
| A MIN         | 9,90  | 9,90  | 12,30 | 14,70 |

4040062/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

## PW (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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Mailing Address: Texas Instruments  
Post Office Box 655303 Dallas, Texas 75265

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